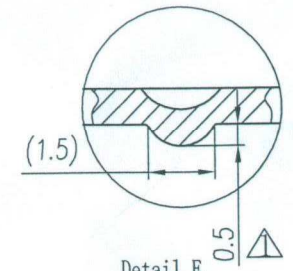
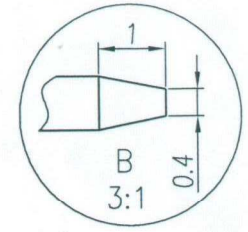
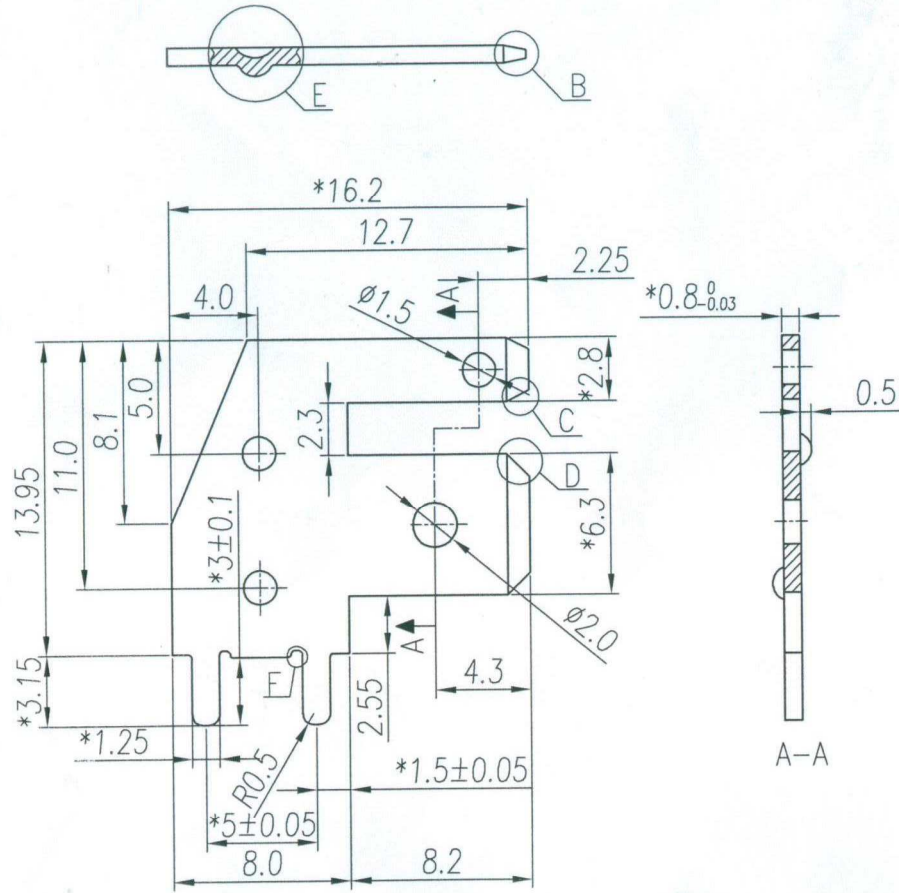
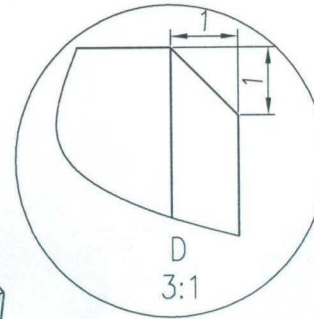
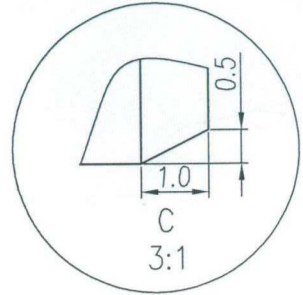


REVISION RECORD				
REV	ECD	DESCRIPTION	DRFT	DATE
△		工艺突点高由0.2改为0.5	YHG	09/27/08



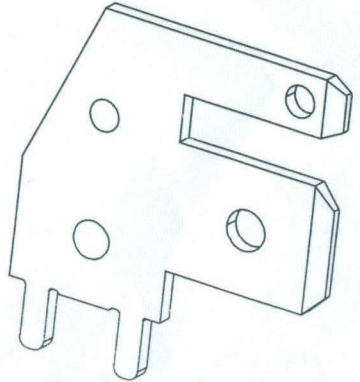
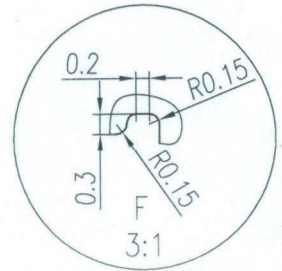
Detail E
Scale: 2:1
add a point which can make a better effect when plating



Notes:

1. Material: H62 Brass, T=0.8mm;
2. Plating: Cu plated at the bottom is more than 1um; Ni plated on the surface is more than 0.3um; Sn plated at the bottom is more than 4um;
3. Undimensioned Tolerances:

Pitch range in mm		Nominal dimension range in mm						
to	over	to	over	to	over	to	over	
6	10	10	30	30	60	60	100	100
10	24	24	60	60	100	150	150	150
±0.10	±0.15	±0.25	±0.2	±0.3	±0.5	±0.7	±1.0	±0.005/0.010



1	K33	C3310	Brass	SnCe	
ITEM	NAME OF PART	NO. OF PART	Q'TY	MATERIAL	NOTES
MM (INCH)		DFTD HY	DATE 07/07/15'	DEGSON 宁波高正电子有限公司 DEGSON ELECTRONICS CO., LTD	
TOLERANCES EXCEPT AS NOTED		CHKD	DATE	NAME K33-00A (H)	
MM		MFD	DATE	DRAWING NO. K33-E01	
.01 ±		APPVL	DATE	/PART NO.	
.00 ±		MATERIAL :		SIZE A4	
.000 ±		G.E :		REV T1-1	
ANGLES ± 1°		FINISH:		07/07/15'	
THIRD ANGLE PROJECTION		SCALE : 1:1		DO NOT SCALE DRAWING	
			SHEET 1		OF 1